

Lam Research Corporation designs, manufactures, markets, refurbishes, and services semiconductor processing equipment used in the fabrication of integrated circuits. The company offers ALTUS systems to deposit conformal films for tungsten metallization applications; SABRE electrochemical deposition products for copper interconnect transition that offers copper damascene manufacturing; SOLA ultraviolet thermal processing products for film treatments; and VECTOR plasma-enhanced CVD ALD products. It also provides SPEED gapfill high-density plasma chemical vapor deposition products; and Striker single-wafer atomic layer deposition products for dielectric film solutions. In addition, the company offers Flex for dielectric etch applications; Kiyo for conductor etch applications; Syndion for through-silicon via etch applications; and Versys metal products for metal etch processes. Further, it provides Coronus bevel clean products to enhance die yield; Da Vinci, DV-Prime, EOS, and SP series products to address various wafer cleaning applications; and Metryx mass metrology systems for high precision in-line mass measurement in semiconductor wafer manufacturing. The company sells its products and services to semiconductors industry in the United States, China, Europe, Japan, Korea, Southeast Asia, Taiwan, and internationally. Lam Research Corporation was incorporated in 1980 and is headquartered in Fremont, California.

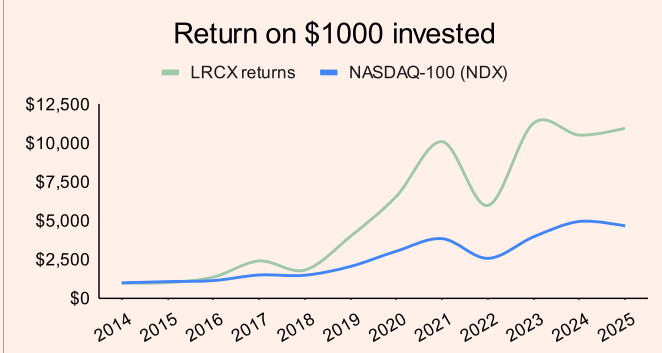
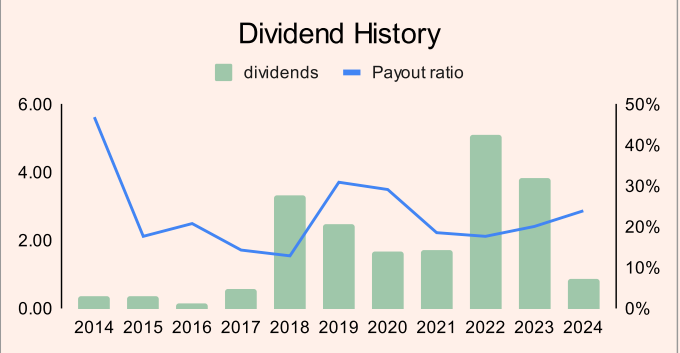
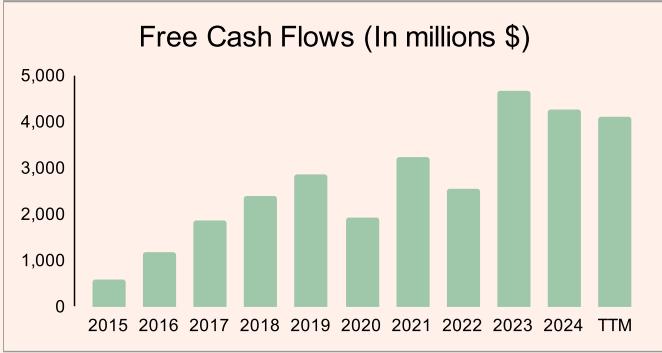
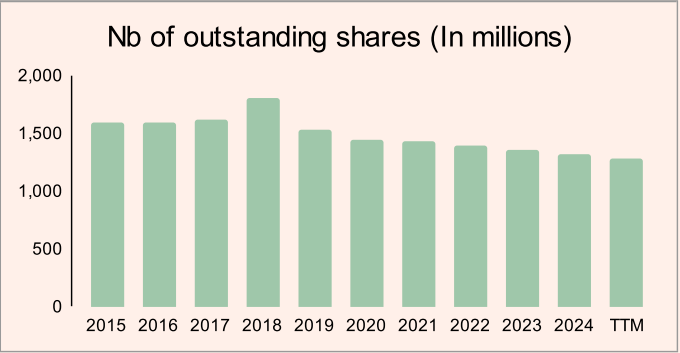
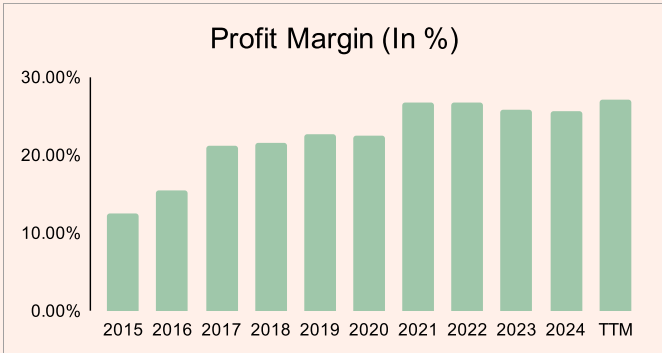
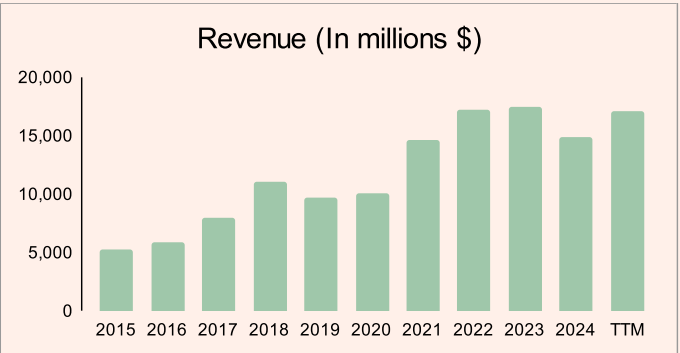
THEDIVIDENDPRINCE.COM

Price	52 week low	52 week high	Total shares outstanding	Market cap	Exchange market
75.03	56.3	113	1279 Millions shares	96 Billions	NASDAQ

Thedividendprince rating*
8.67/10

Key Metrics
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Blue Chips	Yes	✔
Brand ranking**	No Ranking	✖
Revenue (CAGR) 10 years	12.54%	✔
Net income (CAGR) 10 years	21.66%	✔
EPS (CAGR) 10 years	24.27%	✔
Price earnings ratio	20.65	✔
Net Profit Margin TTM	27.19%	✔
Dividend payout ratio	23.95%	✔
Dividend yield	1.19%	✖
Return on equity (10y average)	41.55%	✔
Return on Tangible assets (10y average)	20.14%	✔
Return on Invested Capital TTM	30.37%	✔
Debt to equity (10y average)	0.68	✔
Debt to assets (10y average)	0.29	✔
Price to book ratio TTM	1.72	✔
Fair Value (Morningstar)	86	✔
Economic Moat (Morningstar)	Wide	✔
Long term debt rating (Moody's)	A2	✔
Short term debt rating (Moody's)	P-1	✔
Dividend Cut Risk Score	35.93%	✔
ESG Risk Rating (Morningstar)	12.21	✔
Financial Strength Score (Piotroski Score)	7	✔
Last Earning Call AI Sentiment Analysis	neutral	✖
Stock beats the ref. index for the last 10 years		✔
steady revenue ?		✔
Steady net income ?		✔
Steady profit margin positive ?		✔
Steady FCF ?		✔
steady dividends and increasing ?		✖
Nb of shares decreasing ?		✔



\*Thedividendprince rating is explained here

\*\*Brand ranking source

Disclaimer :Nothing presented herein is, or is intended to constitute, specific investment advice. Nothing in this document should be seen as a recommendation to follow any investment strategy. Errors may occur.